P-Ch MOSFET

General Description

Description The WSD20L75DN uses advanced trench technology and design to provide excellent $R_{\text{DS(ON)}}$ with low gate charge. It can be used in a wide variety of applications.

Features

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

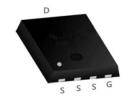
Product Summery

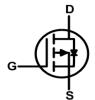
BV _{DSS}	R _{DSON}	I _D		
-20V	4.8mΩ	-75A		

Applications

- Load switch
- Battery protection

DFN3X3-8 Pin Configuration





Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	-20	V
V _{GS}	Gate-Source Voltage	±12	V
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ -10V ¹	-75	А
I _D @T _C =100℃	Continuous Drain Current, V _{GS} @ -10V ¹	-55	А
I _D @T _A =25℃	Continuous Drain Current, V _{GS} @ -10V ¹	-13	А
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ -10V ¹	-10	А
I _{DM}	Pulsed Drain Current ²	-200	А
EAS	Single Pulse Avalanche Energy ³	125	mJ
I _{AS}	Avalanche Current	-50	А
P _D @T _C =25°C	Total Power Dissipation ⁴	83	W
P _D @T _A =25℃	Total Power Dissipation ⁴	6.2	W
T _{STG}	Storage Temperature Range	-55 to 150	$^{\circ}$ C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
$R_{ heta JA}$	Thermal Resistance Junction-Ambient ¹		55	°C/W
$R_{ heta JA}$	Thermal Resistance Junction-Ambient ¹ (t ≤10s)		20	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹		1.5	°C/W



Electrical Characteristics (T_J=25 C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-20			V
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25 $^{\circ}$ C , I _D =-1mA		-0.0232		V/°C
		V _{GS} =-4.5V , I _D =-20A		4.8	6.0	
		V_{GS} =-2.5 V , I_D =-20 A		6.2	8	
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =-1.8V , I _D =-10A		8.0	10	mΩ
		V _{GS} =-1.5V , I _D =-8A		12	15.5	
		V _{GS} =-1.2V , I _D =-5A		17.6	19.5	
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} . I _D =-250uA	-0.4	-0.6	-1.0	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	VGS=VDS, ID =-250UA		4.6		mV/℃
	Drain Source Lookage Current	V _{DS} =-20V , V _{GS} =0V , T _J =25℃			-1	uA
I _{DSS}	Drain-Source Leakage Current	V_{DS} =-20V , V_{GS} =0V , T_J =55 $^{\circ}$ C			-5	
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 8V$, V_{DS} =0V			±100	nA
gfs	Forward Transconductance	V_{DS} =-5V , I_{D} =-20A		80		S
R_g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		3		Ω
Qg	Total Gate Charge (-4.5V)			55	75	
Q_gs	Gate-Source Charge	V_{DS} =-10V , V_{GS} =-4.5V , I_{D} =-20A		10		nC
Q_gd	Gate-Drain Charge			15		
T _{d(on)}	Turn-On Delay Time			18		
T _r	Rise Time	V_{DD} =-10V , V_{GS} =-4.5V ,		42		no
$T_{d(off)}$	Turn-Off Delay Time	$R_G=3\Omega$ $I_D=-20A$, $R_L=0.5\Omega$		85		ns
T _f	Fall Time			23		
C _{iss}	Input Capacitance	V _{DS} =-15V , V _{GS} =0V , f=1MHz		3500		
Coss	Output Capacitance			577		pF
C _{rss}	Reverse Transfer Capacitance			445		

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy ⁵	V _{DD} =-10V , L=0.5mH , I _{AS} =-10A	100			mJ

Diode Characteristics

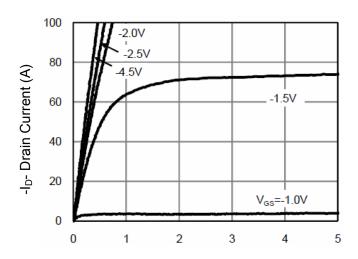
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I _S	Continuous Source Current ^{1,6}	V _G =V _D =0V , Force Current			-45	Α
I _{SM}	Pulsed Source Current ^{2,6}				-90	Α
V_{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =-10A , T _J =25°C			-1.2	V
t _{rr}	Reverse Recovery Time	IF=-10A,dI/dt=100A/µs, T _J =25℃		47		nS
Q _{rr}	Reverse Recovery Charge			53		nC

Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t≤10sec.
- 2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =-10V, V_{GS} =-10V,L=0.1mH, I_{AS} =-10A
- 4.The power dissipation is limited by 150 $^{\circ}\mathrm{C}$ junction temperature
- 5.The Min. value is 100% EAS tested guarantee.
- 6. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics



-Vds Drain-Source Voltage (V)



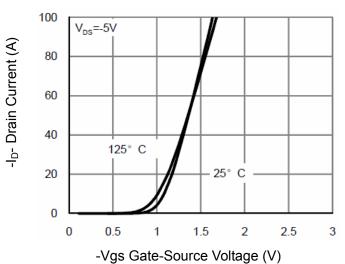


Figure 2 Transfer Characteristics

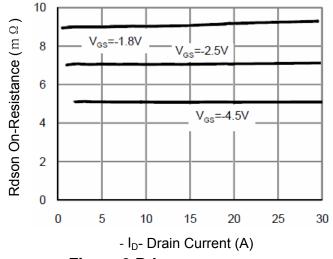
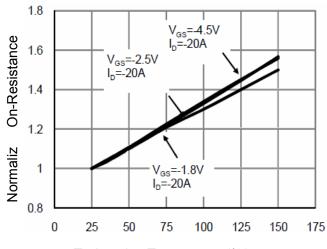


Figure 3 Rdson- Drain Current



 T_J -Junction Temperature($^{\circ}$ C)

Figure 4 Rdson-Junction Temperature

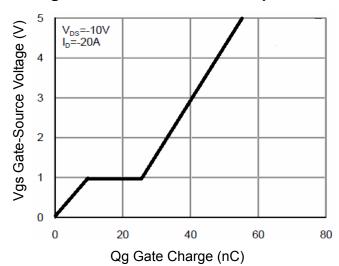


Figure 5 Gate Charge

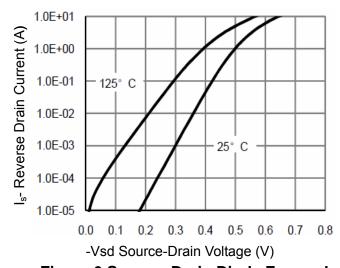
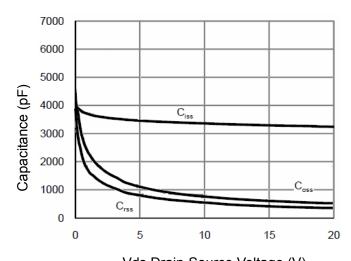


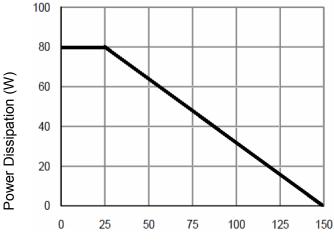
Figure 6 Source- Drain Diode Forward





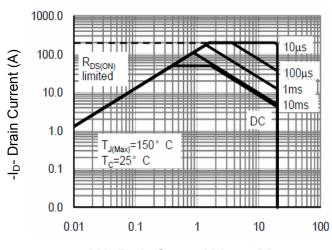
-Vds Drain-Source Voltage (V)

Figure 7 Capacitance vs Vds



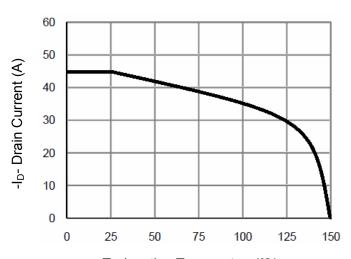
T_J-Junction Temperature(°C)





-Vds Drain-Source Voltage (V)

Figure 8 Safe Operation Area



T_J-Junction Temperature(°C)

Figure 10 -Current De-rating

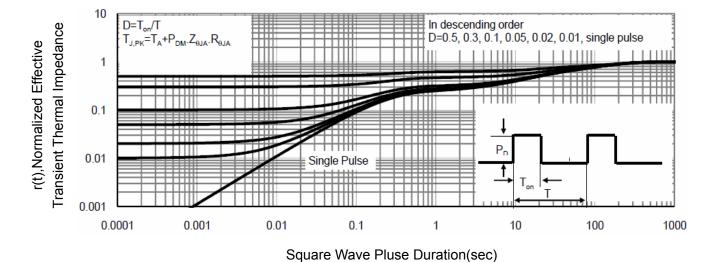


Figure 11 Normalized Maximum Transient Thermal Impedance



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